



# PMBTA45-Q

500 V, 150 mA NPN high-voltage low V<sub>CEsat</sub> transistor

20 July 2023

Product data sheet

## 1. General description

NPN high-voltage low V<sub>CEsat</sub> transistor in a SOT23 small Surface-Mounted Device (SMD) plastic package.

## 2. Features and benefits

- High voltage
- Low collector-emitter saturation voltage V<sub>CEsat</sub>
- High collector current capability I<sub>C</sub> and I<sub>CM</sub>
- High collector current gain (h<sub>FE</sub>) at high I<sub>C</sub>
- Qualified according to AEC-Q101 and recommended for use in automotive applications

## 3. Applications

- Electronic ballasts
- LED driver for LED chain module
- LCD backlighting
- Automotive motor management
- Flyback converters
- Hook switch for wired telecom
- Switch Mode Power Supply (SMPS)

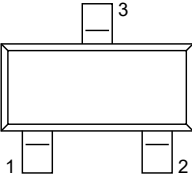
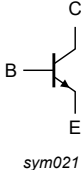
## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V <sub>CESM</sub>	collector-emitter peak voltage	V <sub>BE</sub> = 0 V	-	-	500	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	-	500	V
I <sub>C</sub>	collector current		-	-	0.15	A
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = 10 V; I <sub>C</sub> = 30 mA; T <sub>amb</sub> = 25 °C	50	100	-	

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	B	base	 SOT23	 sym021
2	E	emitter		
3	C	collector		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
<a href="#">PMBTA45-Q</a>	SOT23	plastic, surface-mounted package; 3 terminals; 1.9 mm pitch; 2.9 mm x 1.3 mm x 1 mm body	<a href="#">SOT23</a>

7. Marking

Table 4. Marking codes

Type number	Marking code[1]
PMBTA45-Q	LK%

[1] % = placeholder for manufacturing site code

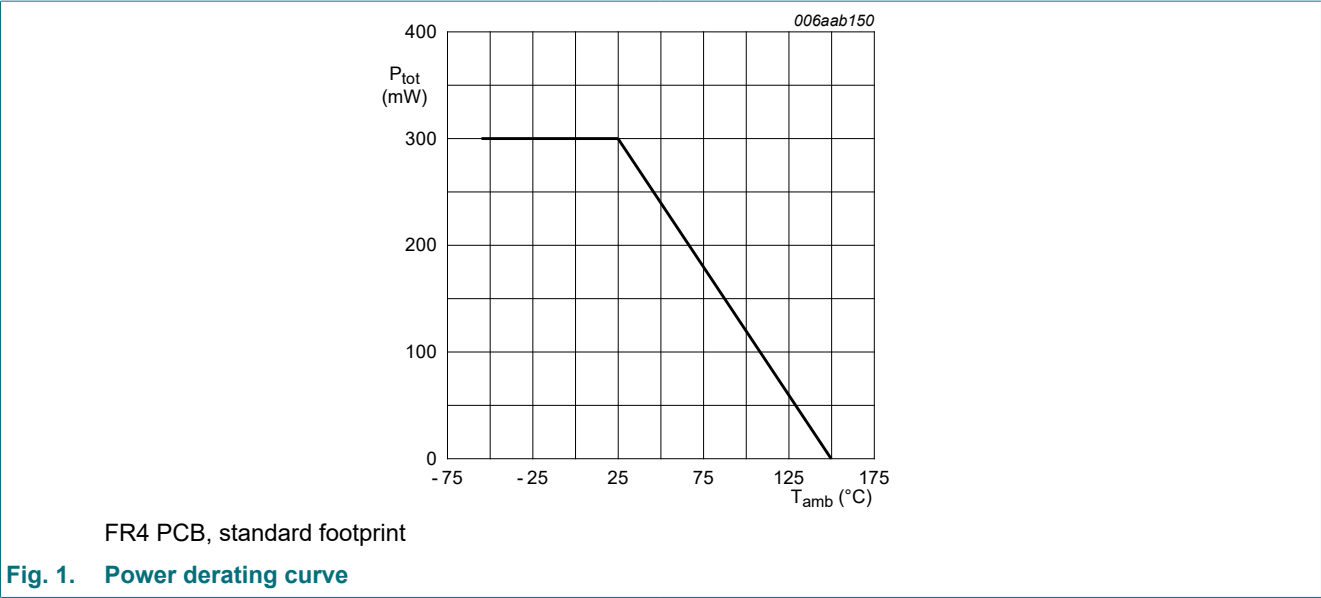
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CBO</sub>	collector-base voltage	open emitter		-	500	V
V <sub>CEO</sub>	collector-emitter voltage	open base		-	500	V
V <sub>CESM</sub>	collector-emitter peak voltage	V <sub>BE</sub> = 0 V		-	500	V
V <sub>EBO</sub>	emitter-base voltage	open collector		-	6	V
I <sub>C</sub>	collector current			-	0.15	A
I <sub>CM</sub>	peak collector current	single pulse; t <sub>p</sub> ≤ 1 ms		-	0.5	A
I <sub>BM</sub>	peak base current			-	200	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	300	mW
T <sub>j</sub>	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

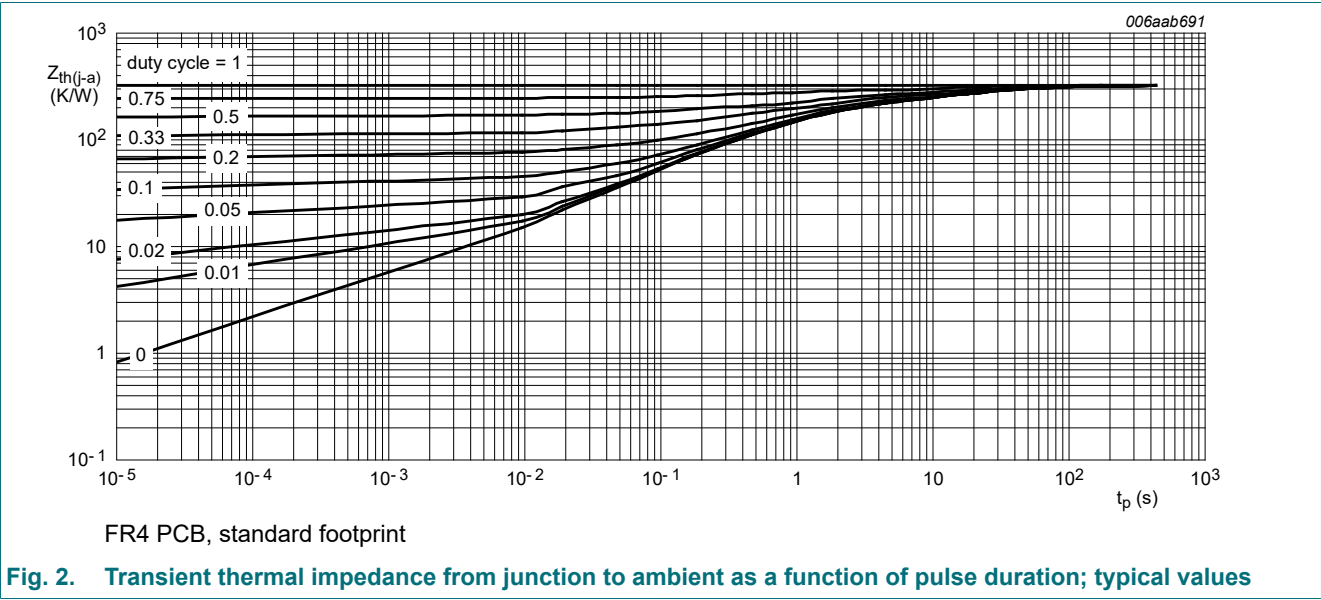


9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	417	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point			-	-	70	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.



10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
I <sub>CBO</sub>	collector-base cut-off current	V <sub>CB</sub> = 360 V; I <sub>E</sub> = 0 A; T <sub>amb</sub> = 25 °C		-	-	100	nA
		V <sub>CB</sub> = 360 V; I <sub>E</sub> = 0 A; T <sub>j</sub> = 150 °C		-	-	10	µA
I <sub>EBO</sub>	emitter-base cut-off current	V <sub>EB</sub> = 5 V; I <sub>C</sub> = 0 A; T <sub>amb</sub> = 25 °C		-	-	100	nA
I <sub>CES</sub>	collector-emitter cut-off current	V <sub>CE</sub> = 360 V; V <sub>BE</sub> = 0 V; T <sub>amb</sub> = 25 °C		-	-	100	nA
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = 10 V; I <sub>C</sub> = 30 mA; T <sub>amb</sub> = 25 °C		50	100	-	
		V <sub>CE</sub> = 10 V; I <sub>C</sub> = 50 mA; pulsed; t <sub>p</sub> ≤ 300 µs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C		50	100	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	I <sub>C</sub> = 20 mA; I <sub>B</sub> = 2 mA; T <sub>amb</sub> = 25 °C		-	60	75	mV
		I <sub>C</sub> = 50 mA; I <sub>B</sub> = 6 mA; pulsed; t <sub>p</sub> ≤ 300 µs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C		-	65	90	mV
V <sub>BEsat</sub>	base-emitter saturation voltage	I <sub>C</sub> = 50 mA; I <sub>B</sub> = 5 mA; pulsed; t <sub>p</sub> ≤ 300 µs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C		-	0.75	0.9	V
t <sub>d</sub>	delay time	V <sub>CC</sub> = 20 V; I <sub>C</sub> = 0.05 A; I <sub>Bon</sub> = 5 mA; I <sub>Boff</sub> = -10 mA; T <sub>amb</sub> = 25 °C		-	80	-	ns
t <sub>r</sub>	rise time			-	2700	-	ns
t <sub>on</sub>	turn-on time			-	2780	-	ns
t <sub>s</sub>	storage time			-	3400	-	ns
t <sub>f</sub>	fall time			-	800	-	ns
t <sub>off</sub>	turn-off time			-	4200	-	ns
f <sub>T</sub>	transition frequency	V <sub>CE</sub> = 10 V; I <sub>C</sub> = 10 mA; f = 100 MHz; T <sub>amb</sub> = 25 °C		-	35	-	MHz
C <sub>c</sub>	collector capacitance	V <sub>CB</sub> = 20 V; I <sub>E</sub> = 0 A; i <sub>e</sub> = 0 A; f = 1 MHz; T <sub>amb</sub> = 25 °C		-	4	-	pF
C <sub>e</sub>	emitter capacitance	V <sub>EB</sub> = 0.5 V; I <sub>C</sub> = 0 A; i <sub>c</sub> = 0 A; f = 1 MHz; T <sub>amb</sub> = 25 °C		-	200	-	pF

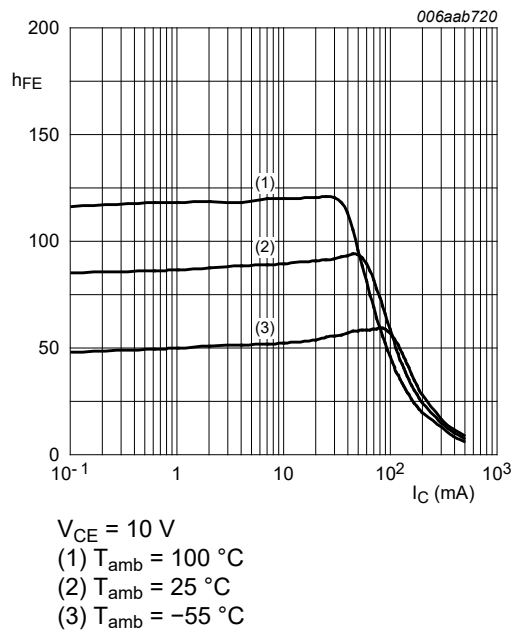


Fig. 3. DC current gain as a function of collector current; typical values

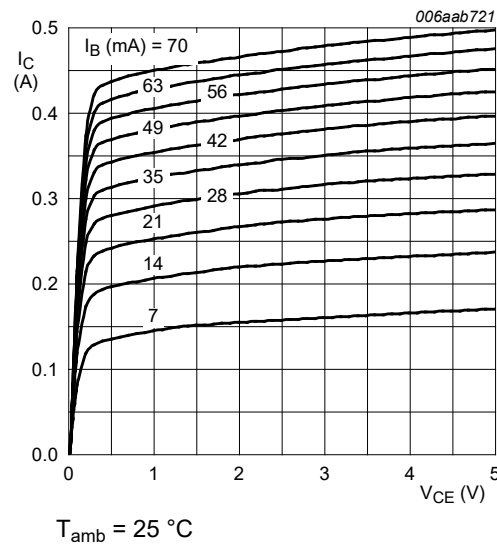


Fig. 4. Collector current as a function of collector-emitter voltage; typical values

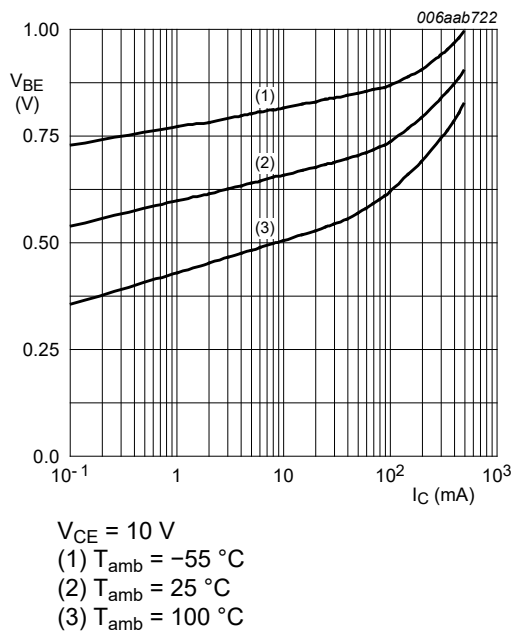


Fig. 5. Base-emitter voltage as a function of collector current; typical values

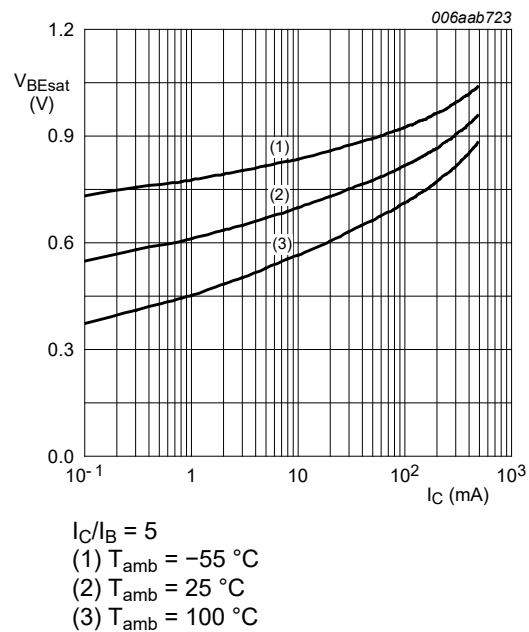


Fig. 6. Base-emitter saturation voltage as a function of collector current; typical values

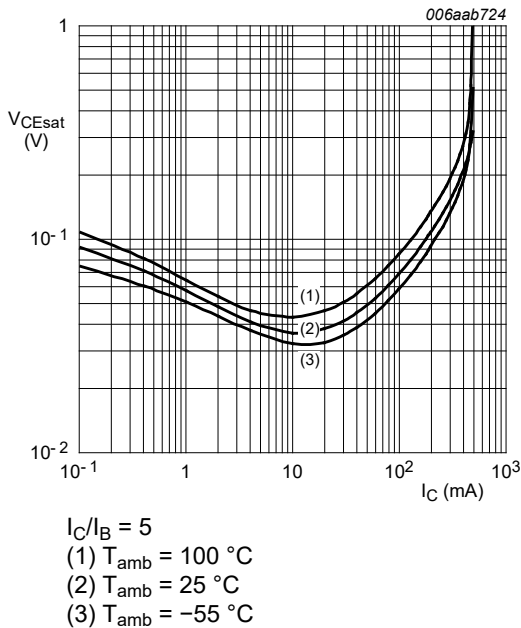


Fig. 7. Collector-emitter saturation voltage as a function of collector current; typical values

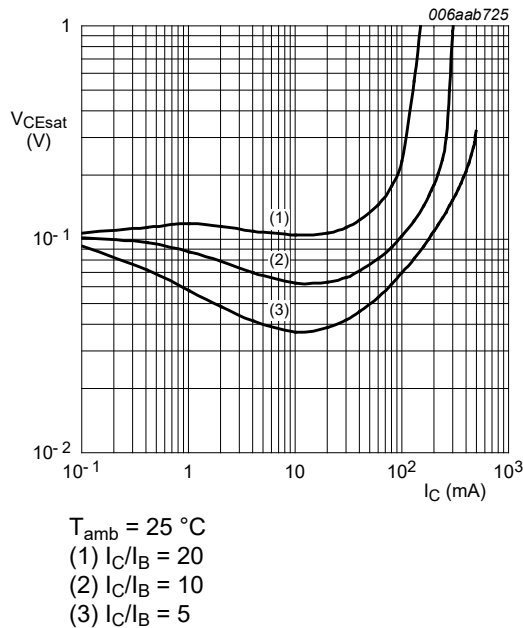


Fig. 8. Collector-emitter saturation voltage as a function of collector current; typical values

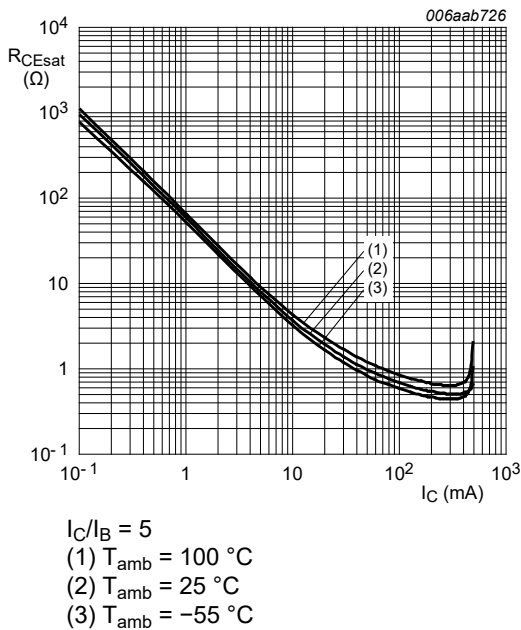


Fig. 9. Collector-emitter saturation resistance as a function of collector current; typical values

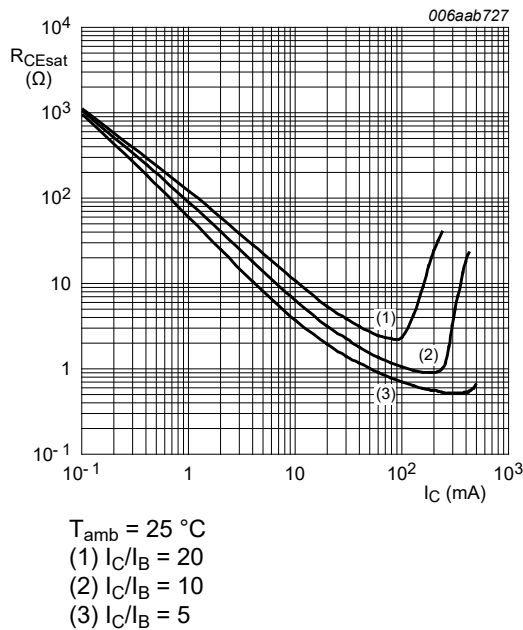


Fig. 10. Collector-emitter saturation resistance as a function of collector current; typical values



13. Soldering

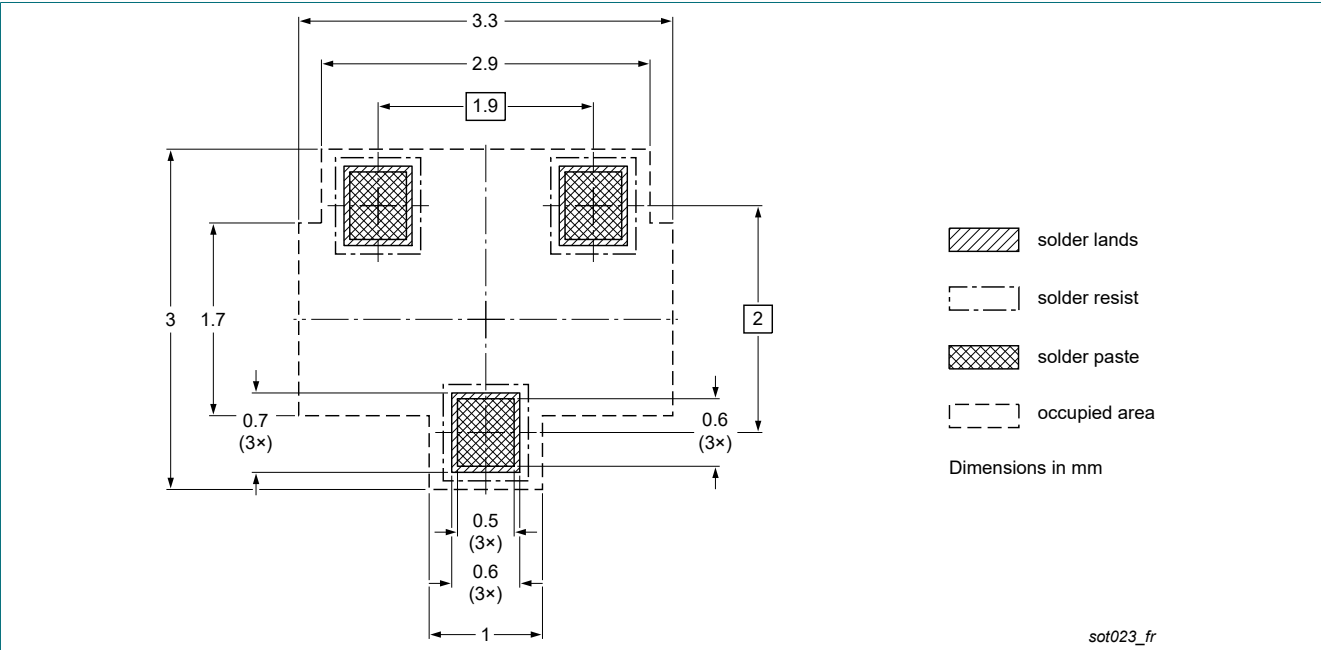


Fig. 13. Reflow soldering footprint for SOT23

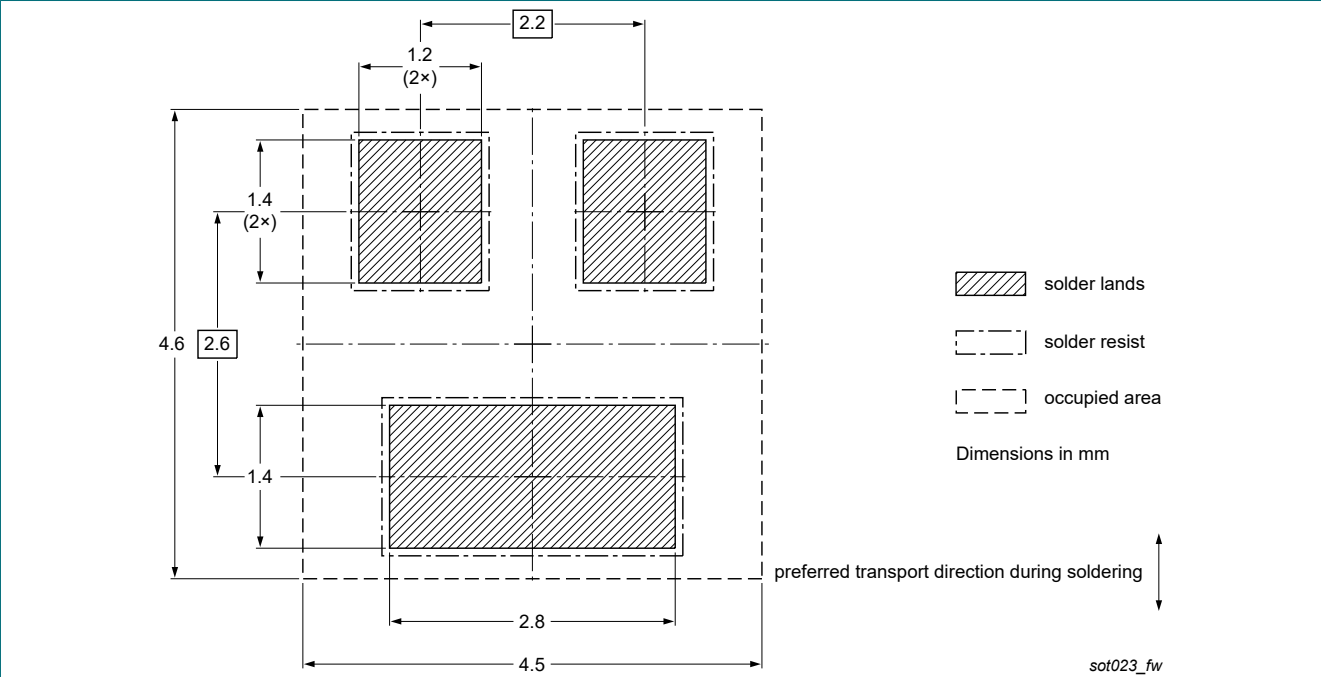


Fig. 14. Wave soldering footprint for SOT23



14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMBTA45-Q v.1	20230720	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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